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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	7612
Number of Logic Elements/Cells	181165
Total RAM Bits	10177536
Number of I/O	372
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	780-BBGA, FCBGA
Supplier Device Package	780-FBGA (29x29)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep2agx190ef29c5n">https://www.e-xfl.com/product-detail/intel/ep2agx190ef29c5n</a>

**Table 1–2. Absolute Maximum Ratings for Arria II GZ Devices (Part 2 of 2)**

Symbol	Description	Minimum	Maximum	Unit
$V_{CCA\_L}$	Supplies transceiver high voltage power (left side)	-0.5	3.75	V
$V_{CCA\_R}$	Supplies transceiver high voltage power (right side)	-0.5	3.75	V
$V_{CHIP\_L}$	Supplies transceiver HIP digital power (left side)	-0.5	1.35	V
$V_{CCR\_L}$	Supplies receiver power (left side)	-0.5	1.35	V
$V_{CCR\_R}$	Supplies receiver power (right side)	-0.5	1.35	V
$V_{CCT\_L}$	Supplies transmitter power (left side)	-0.5	1.35	V
$V_{CCT\_R}$	Supplies transmitter power (right side)	-0.5	1.35	V
$V_{CCL\_GXBLn}$ <i>(1)</i>	Supplies power to the transceiver PMA TX, PMA RX, and clocking (left side)	-0.5	1.35	V
$V_{CCL\_GXBRn}$ <i>(1)</i>	Supplies power to the transceiver PMA TX, PMA RX, and clocking (right side)	-0.5	1.35	V
$V_{CCH\_GXBLn}$ <i>(1)</i>	Supplies power to the transceiver PMA output (TX) buffer (left side)	-0.5	1.8	V
$V_{CCH\_GXBRn}$ <i>(1)</i>	Supplies power to the transceiver PMA output (TX) buffer (right side)	-0.5	1.8	V
$T_J$	Operating junction temperature	-55	125	°C
$T_{STG}$	Storage temperature (no bias)	-65	150	°C

**Note to Table 1–2:**

(1) n = 0, 1, or 2.

### Maximum Allowed Overshoot and Undershoot Voltage

During transitions, input signals may overshoot to the voltage shown in Table 1–3 and undershoot to -2.0 V for magnitude of currents less than 100 mA and periods shorter than 20 ns.

Table 1–3 lists the Arria II GX and GZ maximum allowed input overshoot voltage and the duration of the overshoot voltage as a percentage over the device lifetime. The maximum allowed overshoot duration is specified as a percentage of high-time over the lifetime of the device. A DC signal is equivalent to 100% duty cycle. For example, a signal that overshoots to 4.3 V can only be at 4.3 V for 5.41% over the lifetime of the device; for a device lifetime of 10 years, this amounts to 5.41/10ths of a year.

**Table 1–3. Maximum Allowed Overshoot During Transitions for Arria II Devices**

<b>Symbol</b>	<b>Description</b>	<b>Condition (V)</b>	<b>Overshoot Duration as % of High Time</b>	<b>Unit</b>
V <sub>I</sub> (AC)	AC Input Voltage	4.0	100.000	%
		4.05	79.330	%
		4.1	46.270	%
		4.15	27.030	%
		4.2	15.800	%
		4.25	9.240	%
		4.3	5.410	%
		4.35	3.160	%
		4.4	1.850	%
		4.45	1.080	%
		4.5	0.630	%
		4.55	0.370	%
		4.6	0.220	%

**Maximum Allowed I/O Operating Frequency**

Table 1–4 lists the maximum allowed I/O operating frequency for Arria II GX I/Os using the specified I/O standards to ensure device reliability.

**Table 1–4. Maximum Allowed I/O Operating Frequency for Arria II GX Devices**

<b>I/O Standard</b>	<b>I/O Frequency (MHz)</b>
HSTL-18 and HSTL-15	333
SSTL -15	400
SSTL-18	333
2.5-V LVCMOS	260
3.3-V and 3.0-V LVTTL	250
3.3-V, 3.0-V, 1.8-V, and 1.5-V LVCMOS	
PCI and PCI-X	
SSTL-2	200
1.2-V LVCMOS HSTL-12	

## I/O Pin Leakage Current

Table 1-7 lists the Arria II GX I/O pin leakage current specifications.

**Table 1-7. I/O Pin Leakage Current for Arria II GX Devices**

Symbol	Description	Conditions	Min	Typ	Max	Unit
$I_I$	Input pin	$V_I = 0 \text{ V to } V_{CCIO MAX}$	-10	—	10	$\mu\text{A}$
$I_{OZ}$	Tri-stated I/O pin	$V_O = 0 \text{ V to } V_{CCIO MAX}$	-10	—	10	$\mu\text{A}$

Table 1-8 lists the Arria II GZ I/O pin leakage current specifications.

**Table 1-8. I/O Pin Leakage Current for Arria II GZ Devices**

Symbol	Description	Conditions	Min	Typ	Max	Unit
$I_I$	Input pin	$V_I = 0 \text{ V to } V_{CCIO MAX}$	-20	—	20	$\mu\text{A}$
$I_{OZ}$	Tri-stated I/O pin	$V_O = 0 \text{ V to } V_{CCIO MAX}$	-20	—	20	$\mu\text{A}$

## Bus Hold

Bus hold retains the last valid logic state after the source driving it either enters the high impedance state or is removed. Each I/O pin has an option to enable bus hold in user mode. Bus hold is always disabled in configuration mode.

Table 1-9 lists bus hold specifications for Arria II GX devices.

**Table 1-9. Bus Hold Parameters for Arria II GX Devices (Note 1)**

Parameter	Symbol	Cond.	$V_{CCIO} (\text{V})$												Unit	
			1.2		1.5		1.8		2.5		3.0		3.3			
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
Bus-hold low, sustaining current	$I_{SUSL}$	$V_{IN} > V_{IL} (\text{max.})$	8	—	12	—	30	—	50	—	70	—	70	—	$\mu\text{A}$	
Bus-hold high, sustaining current	$I_{SUSH}$	$V_{IN} < V_{IL} (\text{min.})$	-8	—	-12	—	-30	—	-50	—	-70	—	-70	—	$\mu\text{A}$	
Bus-hold low, overdrive current	$I_{ODL}$	$0 \text{ V} < V_{IN} < V_{CCIO}$	—	125	—	175	—	200	—	300	—	500	—	500	$\mu\text{A}$	
Bus-hold high, overdrive current	$I_{ODH}$	$0 \text{ V} < V_{IN} < V_{CCIO}$	—	-125	—	-175	—	-200	—	-300	—	-500	—	-500	$\mu\text{A}$	
Bus-hold trip point	$V_{TRIP}$	—	0.3	0.9	0.375	1.125	0.68	1.07	0.7	1.7	0.8	2	0.8	2	V	

### Note to Table 1-9:

- (1) The bus-hold trip points are based on calculated input voltages from the JEDEC standard.

Table 1–10 lists the bus hold specifications for Arria II GZ devices.

**Table 1–10. Bus Hold Parameters for Arria II GZ Devices**

Parameter	Symbol	Cond.	V <sub>CCIO</sub> (V)										Unit	
			1.2		1.5		1.8		2.5		3.0			
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
Bus-hold Low sustaining current	I <sub>SUSL</sub>	V <sub>IN</sub> > V <sub>IL</sub> (max.)	22.5	—	25.0	—	30.0	—	50.0	—	70.0	—	μA	
Bus-hold High sustaining current	I <sub>SUSH</sub>	V <sub>IN</sub> < V <sub>IH</sub> (min.)	-22.5	—	-25.0	—	-30.0	—	-50.0	—	-70.0	—	μA	
Bus-hold Low overdrive current	I <sub>ODL</sub>	0V < V <sub>IN</sub> < V <sub>CCIO</sub>	—	120	—	160	—	200	—	300	—	500	μA	
Bus-hold High overdrive current	I <sub>ODH</sub>	0V < V <sub>IN</sub> < V <sub>CCIO</sub>	—	-120	—	-160	—	-200	—	-300	—	-500	μA	
Bus-hold trip point	V <sub>TRIP</sub>	—	0.45	0.95	0.50	1.00	0.68	1.07	0.70	1.70	0.80	2.00	V	

### OCT Specifications

Table 1–11 lists the Arria II GX device and differential OCT with and without calibration accuracy.

**Table 1–11. OCT With and Without Calibration Specification for Arria II GX Device I/Os (Note 1) (Part 1 of 2)**

Symbol	Description	Conditions (V)	Calibration Accuracy		Unit
			Commercial	Industrial	
25-Ω R <sub>S</sub> 3.0, 2.5	25-Ω series OCT without calibration	V <sub>CCIO</sub> = 3.0, 2.5	± 30	± 40	%
50-Ω R <sub>S</sub> 3.0, 2.5	50-Ω series OCT without calibration	V <sub>CCIO</sub> = 3.0, 2.5	± 30	± 40	%
25-Ω R <sub>S</sub> 1.8	25-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.8	± 40	± 50	%
50-Ω R <sub>S</sub> 1.8	50-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.8	± 40	± 50	%
25-Ω R <sub>S</sub> 1.5, 1.2	25-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.5, 1.2	± 50	± 50	%
50-Ω R <sub>S</sub> 1.5, 1.2	50-Ω series OCT without calibration	V <sub>CCIO</sub> = 1.5, 1.2	± 50	± 50	%
25-Ω R <sub>S</sub> 3.0, 2.5, 1.8, 1.5, 1.2	25-Ω series OCT with calibration	V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2	± 10	± 10	%

## I/O Standard Specifications

Table 1–22 through Table 1–35 list input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by the Arria II device family. They also show the Arria II device family I/O standard specifications.  $V_{OL}$  and  $V_{OH}$  values are valid at the corresponding  $I_{OH}$  and  $I_{OL}$ , respectively.



For an explanation of terms used in Table 1–22 through Table 1–35, refer to “Glossary” on page 1–74.

Table 1–22 lists the single-ended I/O standards for Arria II GX devices.

**Table 1–22. Single-Ended I/O Standards for Arria II GX Devices**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
3.3 V LVTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3 V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	2	-2
3.0 V LVTTL	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.45	2.4	4	-4
3.0 V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V LVCMOS	2.375	2.5	2.625	-0.3	0.7	1.7	$V_{CCIO} + 0.3$	0.4	2	1	-1
1.8 V LVCMOS	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V LVCMOS	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V LVCMOS	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
3.0-V PCI	2.85	3	3.15	—	$0.3 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	$0.35 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5

Table 1–23 lists the single-ended I/O standards for Arria II GZ devices.

**Table 1–23. Single-Ended I/O Standards for Arria II GZ Devices (Part 1 of 2)**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

**Table 1–23. Single-Ended I/O Standards for Arria II GZ Devices (Part 2 of 2)**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>IL</sub> (V)		V <sub>IH</sub> (V)		V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
1.2 V	1.14	1.2	1.26	-0.3	0.35 × V <sub>CCIO</sub>	0.65 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	2	-2
3.0-V PCI	2.85	3	3.15	—	0.3 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	3.6	0.1 × V <sub>CCIO</sub>	0.9 × V <sub>CCIO</sub>	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	0.35 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	—	0.1 × V <sub>CCIO</sub>	0.9 × V <sub>CCIO</sub>	1.5	-0.5

Table 1–24 lists the single-ended SSTL and HSTL I/O reference voltage specifications for Arria II GX devices.

**Table 1–24. Single-Ended SSTL and HSTL I/O Reference Voltage Specifications for Arria II GX Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>REF</sub> (V)			V <sub>TT</sub> (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.49 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.51 × V <sub>CCIO</sub>	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-15 Class I, II	1.425	1.5	1.575	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>
HSTL-18 Class I, II	1.71	1.8	1.89	0.85	0.9	0.95	0.85	0.9	0.95
HSTL-15 Class I, II	1.425	1.5	1.575	0.71	0.75	0.79	0.71	0.75	0.79
HSTL-12 Class I, II	1.14	1.2	1.26	0.48 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.52 × V <sub>CCIO</sub>	—	V <sub>CCIO</sub> /2	—

Table 1–25 lists the single-ended SSTL and HSTL I/O reference voltage specifications for Arria II GZ devices.

**Table 1–25. Single-Ended SSTL and HSTL I/O Reference Voltage Specifications for Arria II GZ Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>REF</sub> (V)			V <sub>TT</sub> (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.49 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.51 × V <sub>CCIO</sub>	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-15 Class I, II	1.425	1.5	1.575	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>	0.47 × V <sub>CCIO</sub>	V <sub>REF</sub>	0.53 × V <sub>CCIO</sub>
HSTL-18 Class I, II	1.71	1.8	1.89	0.85	0.9	0.95	—	V <sub>CCIO</sub> /2	—
HSTL-15 Class I, II	1.425	1.5	1.575	0.68	0.75	0.9	—	V <sub>CCIO</sub> /2	—
HSTL-12 Class I, II	1.14	1.2	1.26	0.47 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.53 × V <sub>CCIO</sub>	—	V <sub>CCIO</sub> /2	—

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 4 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Minimum peak-to-peak differential input voltage $V_{ID}$ (diff p-p)	—	100	—	—	100	—	—	100	—	—	100	—	—	mV
$V_{ICM}$	$V_{ICM} = 0.82\text{ V}$ setting	—	820	—	—	820	—	—	820	—	—	820	—	mV
	$V_{ICM} = 1.1\text{ V}$ setting (7)	—	1100	—	—	1100	—	—	1100	—	—	1100	—	mV
Differential on-chip termination resistors	100- $\Omega$ setting	—	100	—	—	100	—	—	100	—	—	100	—	$\Omega$
Return loss differential mode	PCIe	50 MHz to 1.25 GHz: -10dB												
	XAUI	100 MHz to 2.5 GHz: -10dB												
Return loss common mode	PCIe	50 MHz to 1.25 GHz: -6dB												
	XAUI	100 MHz to 2.5 GHz: -6dB												
Programmable PPM detector (8)	—	$\pm 62.5, 100, 125, 200,$ $250, 300, 500, 1000$												ppm
Run length	—	—	80	—	—	80	—	—	80	—	—	80	—	UI
Programmable equalization	—	—	—	7	—	—	7	—	—	7	—	—	7	dB
Signal detect/loss threshold	PCIe Mode	65	—	175	65	—	175	65	—	175	65	—	175	mV
CDR LTR time (9)	—	—	—	75	—	—	75	—	—	75	—	—	75	$\mu\text{s}$
CDR minimum T1b (10)	—	15	—	—	15	—	—	15	—	—	15	—	—	$\mu\text{s}$

**Table 1–34. Transceiver Specifications for Arria II GX Devices (*Note 1*) (Part 7 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Digital reset pulse width	—	Minimum is 2 parallel clock cycles												

**Notes to Table 1–34:**

- (1) For AC-coupled links, the on-chip biasing circuit is switched off before and during configuration. Ensure that input specifications are not violated during this period.
- (2) The rise/fall time is specified from 20% to 80%.
- (3) To calculate the REFCLK rms phase jitter requirement at reference clock frequencies other than 100 MHz, use the following formula:  

$$\text{REFCLK rms phase jitter at } f \text{ (MHz)} = \text{REFCLK rms phase jitter at 100 MHz} * 100/f.$$
- (4) The minimum reconfig\_clk frequency is 2.5 MHz if the transceiver channel is configured in **Transmitter only** mode. The minimum reconfig\_clk frequency is 37.5 MHz if the transceiver channel is configured in **Receiver only** or **Receiver and Transmitter** mode. For more information, refer to [AN 558: Implementing Dynamic Reconfiguration in Arria II Devices](#).
- (5) If your design uses more than one dynamic reconfiguration controller instances (altgx\_reconfig) to control the transceiver channels (altgx) physically located on the same side of the device, and if you use different reconfig\_clk sources for these altgx\_reconfig instances, the delta time between any two of these reconfig\_clk sources becoming stable must not exceed the maximum specification listed.
- (6) The device cannot tolerate prolonged operation at this absolute maximum.
- (7) You must use the 1.1-V RX V<sub>ICM</sub> setting if the input serial data standard is LVDS and the link is DC-coupled.
- (8) The rate matcher supports only up to  $\pm 300$  parts per million (ppm).
- (9) Time taken to rx\_pll\_locked goes high from rx\_analogreset de-assertion. Refer to [Figure 1–1](#).
- (10) The time in which the CDR must be kept in lock-to-reference mode after rx\_pll\_locked goes high and before rx\_locktodata is asserted in manual mode. Refer to [Figure 1–1](#).
- (11) The time taken to recover valid data after the rx\_locktodata signal is asserted in manual mode. Refer to [Figure 1–1](#).
- (12) The time taken to recover valid data after the rx\_freqlocked signal goes high in automatic mode. Refer to [Figure 1–2](#).
- (13) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.

**Table 1–35. Transceiver Specifications for Arria II GZ Devices (Part 2 of 5)**

Symbol/ Description	Conditions	–C3 and –I3 (1)			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
<b>Transceiver Clocks</b>								
Calibration block clock frequency (cal_blk_clk)	—	10	—	125	10	—	125	MHz
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	MHz
reconfig_clk clock frequency	Dynamic reconfiguration clock frequency	2.5/37.5 (4)	—	50	2.5/37.5 (4)	—	50	MHz
Delta time between reconfig_clks (5)	—	—	—	2	—	—	2	ms
Transceiver block minimum power-down (gxb_powerdown) pulse width	—	1	—	—	1	—	—	μs
<b>Receiver</b>								
Supported I/O Standards	1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS							
Data rate (16)	—	600	—	6375	600	—	3750	Mbps
Absolute V <sub>MAX</sub> for a receiver pin (6)	—	—	—	1.6	—	—	1.6	V
Operational V <sub>MAX</sub> for a receiver pin	—	—	—	1.5	—	—	1.5	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) before device configuration	—	—	—	1.6	—	—	1.6	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) after device configuration	V <sub>ICM</sub> = 0.82 V setting	—	—	2.7	—	—	2.7	V
	V <sub>ICM</sub> = 1.1 V setting (7)	—	—	1.6	—	—	1.6	V
Minimum differential eye opening at receiver serial input pins (8)	Data Rate = 600 Mbps to 5 Gbps Equalization = 0 DC gain = 0 dB	100	—	—	165	—	—	mV
	Data Rate > 5 Gbps Equalization = 0 DC gain = 0 dB	165	—	—	165	—	—	mV
V <sub>ICM</sub>	V <sub>ICM</sub> = 0.82 V setting	820 ± 10%			820 ± 10%			mV
	V <sub>ICM</sub> = 1.1 V setting (7)	1100 ± 10%			1100 ± 10%			mV

**Table 1–35. Transceiver Specifications for Arria II GZ Devices (Part 4 of 5)**

Symbol/ Description	Conditions	–C3 and –I3 (1)			–C4 and –I4			Unit		
		Min	Typ	Max	Min	Typ	Max			
<b>Transmitter</b>										
Supported I/O Standards		1.5-V PCML								
Data rate (14)	—	600	—	6375	600	—	3750	Mbps		
V <sub>OCM</sub>	0.65 V setting	—	650	—	—	650	—	mV		
Differential on-chip termination resistors	85-Ω setting	85 ± 15%			85 ± 15%			Ω		
	100-Ω setting	100 ± 15%			100 ± 15%			Ω		
	120-Ω setting	120 ± 15%			120 ± 15%			Ω		
	150-Ω setting	150 ± 15%			150 ± 15%			Ω		
Differential and common mode return loss	PCIe Gen1 and Gen2 (TX V <sub>OD</sub> =4), XAUI (TX V <sub>OD</sub> =6), HiGig+ (TX V <sub>OD</sub> =6), CEI SR/LR (TX V <sub>OD</sub> =8), SRIO SR (V <sub>OD</sub> =6), SRIO LR (V <sub>OD</sub> =8), CPRI LV (V <sub>OD</sub> =6), CPRI HV (V <sub>OD</sub> =2), OBSAI (V <sub>OD</sub> =6), SATA (V <sub>OD</sub> =4),	Compliant								
Rise time (15)	—	50	—	200	50	—	200	ps		
Fall time (15)	—	50	—	200	50	—	200	ps		
Intra-differential pair skew	—	—	—	15	—	—	15	ps		
Intra-transceiver block transmitter channel-to-channel skew	×4 PMA and PCS bonded mode Example: XAUI, PCIe ×4, Basic ×4	—	—	120	—	—	120	ps		
Inter-transceiver block transmitter channel-to-channel skew	×8 PMA and PCS bonded mode Example: PCIe ×8, Basic ×8	—	—	500	—	—	500	ps		
<b>CMU0 PLL and CMU1 PLL</b>										
Supported Data Range	—	600	—	6375	600	—	3750	Mbps		
p11_powerdown minimum pulse width (tp11_powerdown)	—	1			1			μs		
CMU PLL lock time from p11_powerdown de-assertion	—	—	—	100	—	—	100	μs		

Figure 1–3 shows the differential receiver input waveform.

**Figure 1–3. Receiver Input Waveform**

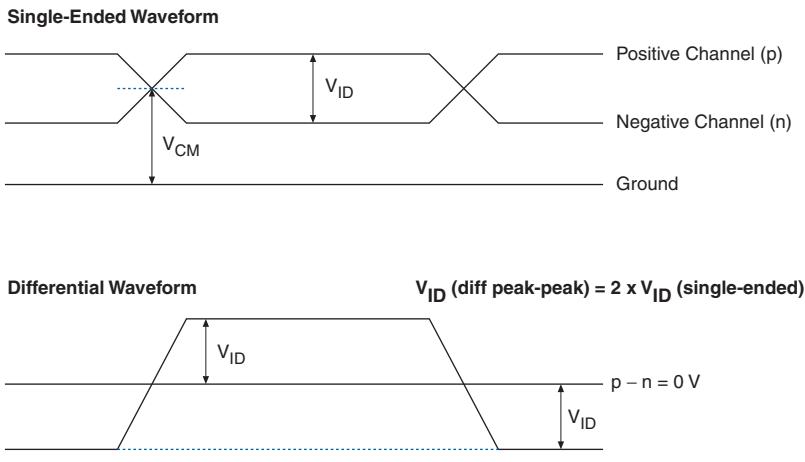


Figure 1–4 shows the transmitter output waveform.

**Figure 1–4. Transmitter Output Waveform**

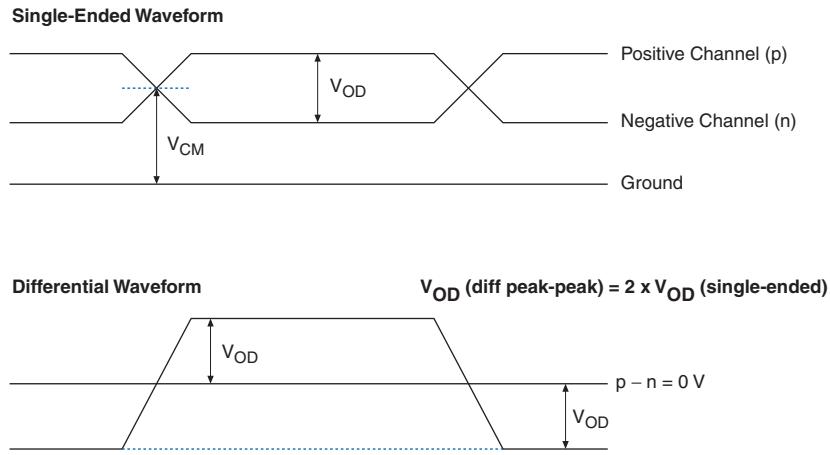


Table 1–36 lists the typical  $V_{OD}$  for TX term that equals 85  $\Omega$  for Arria II GZ devices.

**Table 1–36. Typical  $V_{OD}$  Setting, TX Term = 85  $\Omega$  for Arria II GZ Devices**

<b>Symbol</b>	<b><math>V_{OD}</math> Setting (mV)</b>							
	<b>0</b>	<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>
$V_{OD}$ differential peak-to-peak Typical (mV)	$170 \pm 20\%$	$340 \pm 20\%$	$510 \pm 20\%$	$595 \pm 20\%$	$680 \pm 20\%$	$765 \pm 20\%$	$850 \pm 20\%$	$1020 \pm 20\%$

Table 1–37 lists the typical  $V_{OD}$  for TX term that equals  $100\ \Omega$  for Arria II GX and GZ devices.

**Table 1–37. Typical  $V_{OD}$  Setting, TX Termination =  $100\ \Omega$  for Arria II Devices**

Quartus II Setting	$V_{OD}$ Setting (mV)
1	400
2	600
3 (Arria II GZ)	700
4	800
5	900
6	1000
7	1200

Table 1–38 lists the typical transmitter pre-emphasis levels in dB for the first post tap under the following conditions: low-frequency data pattern (five 1s and five 0s) at 6.375 Gbps. The levels listed in Table 1–38 are a representation of possible pre-emphasis levels under these specified conditions only; the pre-emphasis levels may change with data pattern and data rate.

To predict the pre-emphasis level for your specific data rate and pattern, run simulations using the Arria II GX HSSI HSPICE models.

**Table 1–38. Transmitter Pre-Emphasis Levels for Arria II GX Devices**

Arria II GX (Quartus II Software) First Post Tap Setting	Arria II GX (Quartus II Software) $V_{OD}$ Setting						
	1	2	4	5	6	7	Unit
0 (off)	0	0	0	0	0	0	—
1	0.7	0	0	0	0	0	dB
2	2.7	1.2	0.3	0	0	0	dB
3	4.9	2.4	1.2	0.8	0.5	0.2	dB
4	7.5	3.8	2.1	1.6	1.2	0.6	dB
5	—	5.3	3.1	2.4	1.8	1.1	dB
6	—	7	4.3	3.3	2.7	1.7	dB

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 5 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
<b>SDI Transmitter Jitter Generation (8)</b>														
Alignment jitter (peak-to-peak)	Data rate = 1.485 Gbps (HD) pattern = Color Bar Low- frequency Roll-off = 100 KHz	0.2	—	—	0.2	—	—	0.2	—	—	0.2	—	—	UI
	Data rate = 2.97 Gbps (3G) pattern = Color bar Low- frequency Roll-off = 100 KHz	0.3	—	—	0.3	—	—	0.3	—	—	0.3	—	—	UI
<b>SDI Receiver Jitter Tolerance (8)</b>														
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 15 KHz  Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 2		> 2		> 2		> 2		> 2		> 2		UI
	Jitter frequency = 100 KHz  Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		UI
	Jitter frequency = 148.5 MHz  Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 8 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
<b>CPRI Transmit Jitter Generation (11)</b>														
Total jitter	E.6.HV, E.12.HV Pattern = CJPAT	—	—	0.279	—	—	0.279	—	—	0.279	—	—	0.279	UI
	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Deterministic jitter	E.6.HV, E.12.HV Pattern = CJPAT	—	—	0.14	—	—	0.14	—	—	0.14	—	—	0.14	UI
	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	—	—	0.17	—	—	0.17	—	—	0.17	—	—	0.17	UI
<b>CPRI Receiver Jitter Tolerance (11)</b>														
Total jitter tolerance	E.6.HV, E.12.HV Pattern = CJPAT	> 0.66			> 0.66			> 0.66			> 0.66			UI
Deterministic jitter tolerance	E.6.HV, E.12.HV Pattern = CJPAT	> 0.4			> 0.4			> 0.4			> 0.4			UI
Total jitter tolerance	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	> 0.65			> 0.65			> 0.65			> 0.65			UI
	E.60.LV Pattern = PRBS31	> 0.6			—			—			—			UI
Deterministic jitter tolerance	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	> 0.37			> 0.37			> 0.37			> 0.37			UI
	E.60.LV Pattern = PRBS31	> 0.45			—			—			—			UI
Combined deterministic and random jitter tolerance	E.6.LV, E.12.LV, E.24.LV, E.30.LV Pattern = CJTPAT	> 0.55			> 0.55			> 0.55			> 0.55			UI
<b>OBSAI Transmit Jitter Generation (12)</b>														
Total jitter at 768 Mbps, 1536 Mbps, and 3072 Mbps	REFCLK = 153.6 MHz Pattern = CJPAT	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Deterministic jitter at 768 Mbps, 1536 Mbps, and 3072 Mbps	REFCLK = 153.6 MHz Pattern = CJPAT	—	—	0.17	—	—	0.17	—	—	0.17	—	—	0.17	UI

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 3 of 3)**

<b>Symbol</b>	<b>Description</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$t_{CASC\_OUTJITTER\_PERIOD\_DEDCLK}$ <b>(6), (7)</b>	Period Jitter for dedicated clock output in cascaded PLLs ( $f_{OUT} \geq 100$ MHz)	—	—	425	ps (p-p)
	Period Jitter for dedicated clock output in cascaded PLLs ( $f_{OUT} \leq 100$ MHz)	—	—	42.5	mUI (p-p)

**Notes to Table 1–44:**

- (1)  $f_{IN}$  is limited by the I/O  $f_{MAX}$ .
- (2) The VCO frequency reported by the Quartus II software in the PLL summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.
- (3) A high-input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean-clock source, which is less than 200 ps.
- (4)  $F_{REF}$  is  $f_{IN}/N$  when  $N = 1$ .
- (5) This specification is limited by the lower of the two: I/O  $f_{MAX}$  or  $f_{OUT}$  of the PLL.
- (6) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in [Table 1–62 on page 1–70](#).
- (7) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59$  MHz  $\leq$  Upstream PLL BW  $< 1$  MHz
  - b. Downstream PLL: Downstream PLL BW  $> 2$  MHz

[Table 1–45](#) lists the PLL specifications for Arria II GZ devices when operating in both the commercial junction temperature range (0° to 85°C) and the industrial junction temperature range (-40° to 100°C).

**Table 1–45. PLL Specifications for Arria II GZ Devices (Part 1 of 2)**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$f_{IN}$	Input clock frequency (-3 speed grade)	5	—	717 (1)	MHz
	Input clock frequency (-4 speed grade)	5	—	717 (1)	MHz
$f_{INPFD}$	Input frequency to the PFD	5	—	325	MHz
$f_{VCO}$	PLL VCO operating range (-3 speed grade)	600	—	1,300	MHz
	PLL VCO operating range (-4 speed grade)	600	—	1,300	MHz
$t_{EINDUTY}$	Input clock or external feedback clock input duty cycle	40	—	60	%
$f_{OUT}$	Output frequency for internal global or regional clock (-3 speed grade)	—	—	700 (2)	MHz
	Output frequency for internal global or regional clock (-4 speed grade)	—	—	500 (2)	MHz
$f_{OUT\_EXT}$	Output frequency for external clock output (-3 speed grade)	—	—	717 (2)	MHz
	Output frequency for external clock output (-4 speed grade)	—	—	717 (2)	MHz
$t_{OUTDUTY}$	Duty cycle for external clock output (when set to 50%)	45	50	55	%
$t_{FCOMP}$	External feedback clock compensation time	—	—	10	ns
$t_{CONFIGPLL}$	Time required to reconfigure scan chain	—	3.5	—	scanclk cycles
$t_{CONFIGPHASE}$	Time required to reconfigure phase shift	—	1	—	scanclk cycles
$f_{SCANCLK}$	scanclk frequency	—	—	100	MHz
$t_{LOCK}$	Time required to lock from end-of-device configuration or de-assertion of areset	—	—	1	ms

**Table 1–45. PLL Specifications for Arria II GZ Devices (Part 2 of 2)**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$t_{DLOCK}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{CLBW}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth (7)	—	4	—	MHz
$t_{PLL\_PSERR}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{ARESET}$	Minimum pulse width on the <code>areset</code> signal	10	—	—	ns
$t_{INCCJ} \text{ (3), (4)}$	Input clock cycle to cycle jitter ( $F_{REF} \geq 100$ MHz)	—	—	0.15	UI (p-p)
	Input clock cycle to cycle jitter ( $F_{REF} < 100$ MHz)	—	—	$\pm 750$	ps (p-p)
$t_{OUTPJ\_DC} \text{ (5)}$	Period Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Period Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTCCJ\_DC} \text{ (5)}$	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTPJ\_IO} \text{ (5), (8)}$	Period Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Period Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{OUTCCJ\_IO} \text{ (5), (8)}$	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{CASC\_OUTPJ\_DC} \text{ (5), (6)}$	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} \geq 100$ MHz)	—	—	250	ps (p-p)
	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} < 100$ MHz)	—	—	25	mUI (p-p)
$f_{DRIFT}$	Frequency drift after PFDENA is disabled for duration of 100 us	—	—	$\pm 10$	%

**Notes to Table 1–45:**

- (1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (2) This specification is limited by the lower of the two: I/O  $F_{MAX}$  or  $F_{OUT}$  of the PLL.
- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source that is less than 120 ps.
- (4)  $F_{REF}$  is  $f_{IN/N}$  when  $N = 1$ .
- (5) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in [Table 1–64 on page 1–71](#).
- (6) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59$  MHz  $\leq$  Upstream PLL BW  $< 1$  MHz
  - b. Downstream PLL: Downstream PLL BW  $> 2$  MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) External memory interface clock output jitter specifications use a different measurement method, which is available in [Table 1–63 on page 1–71](#).

**Table 1–47. DSP Block Performance Specifications for Arria II GZ Devices (*Note 1*) (Part 2 of 2)**

Mode	Resources Used	Performance			Unit
	Number of Multipliers	-3	-4		
Double mode	1	440	380	MHz	

**Notes to Table 1–47:**

- (1) Maximum is for fully pipelined block with **Round** and **Saturation** disabled.
- (2) Maximum for loopback input registers disabled, **Round** and **Saturation** disabled, and pipeline and output registers enabled.

**Embedded Memory Block Specifications**

Table 1–48 lists the embedded memory block specifications for Arria II GX devices.

**Table 1–48. Embedded Memory Block Performance Specifications for Arria II GX Devices**

Memory	Mode	Resources Used		Performance				Unit
		ALUTs	Embedded Memory	I3	C4	C5,I5	C6	
Memory Logic Array Block (MLAB)	Single port 64 × 10	0	1	450	500	450	378	MHz
	Simple dual-port 32 × 20 single clock	0	1	270	500	450	378	MHz
	Simple dual-port 64 × 10 single clock	0	1	428	500	450	378	MHz
M9K Block	Single-port 256 × 36	0	1	360	400	360	310	MHz
	Single-port 256 × 36, with the <b>read-during-write</b> option set to <b>Old Data</b>	0	1	250	280	250	210	MHz
	Simple dual-port 256 × 36 single CLK	0	1	360	400	360	310	MHz
	Single-port 256 × 36 single CLK, with the <b>read-during-write</b> option set to <b>Old Data</b>	0	1	250	280	250	210	MHz
	True dual port 512 × 18 single CLK	0	1	360	400	360	310	MHz
	True dual-port 512 × 18 single CLK, with the <b>read-during-write</b> option set to <b>Old Data</b>	0	1	250	280	250	210	MHz
	Min Pulse Width (clock high time)	—	—	900	850	950	1130	ps
	Min Pulse Width (clock low time)	—	—	730	690	770	920	ps

**Table 1–54. High-Speed I/O Specifications for Arria II GZ Devices (Note 1), (2), (10) (Part 2 of 3)**

<b>Symbol</b>	<b>Conditions</b>	<b>C3, I3</b>			<b>C4, I4</b>			<b>Unit</b>
		<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	
$f_{HSCLK\_OUT}$ (output clock frequency)	—	5	—	717 (7)	5	—	717 (7)	MHz
<b>Transmitter</b>								
$f_{HSDR}$ (true LVDS output data rate)	SERDES factor, J = 3 to 10 (using dedicated SERDES) (8)	(4)	—	1250	(4)	—	1250	Mbps
	SERDES factor J = 2, (using DDR registers)	(4)	—	(5)	(4)	—	(5)	Mbps
	SERDES factor J = 1, (uses an SDR register)	(4)	—	(5)	(4)	—	(5)	Mbps
$f_{HSDR}$ (emulated LVDS_E_3R output data rate) (5)	SERDES factor J = 4 to 10	(4)	—	1152	(4)	—	800	Mbps
$f_{HSDR}$ (emulated LVDS_E_1R output data rate)		(4)	—	200	(4)	—	200	Mbps
$t_{x\ Jitter}$	Total jitter for data rate, 600 Mbps to 1.6 Gbps	—	—	160	—	—	160	ps
	Total jitter for data rate, < 600 Mbps	—	—	0.1	—	—	0.1	UI
$t_{x\ Jitter}$ – emulated differential I/O standards with three external output resistor network	Total jitter for data rate, 600 Mbps to 1.25 Gbps	—	—	300	—	—	325	ps
	Total jitter for data rate < 600 Mbps	—	—	0.2	—	—	0.25	UI
$t_{x\ Jitter}$ – emulated differential I/O standards with one external output resistor network	—	—	—	0.15	—	—	0.15	UI
$t_{DUTY}$	TX output clock duty cycle for both True and emulated differential I/O standards	45	50	55	45	50	55	%

**Table 1–68. Glossary (Part 2 of 4)**

Letter	Subject	Definitions
G, H, I, J	J JTAG Timing Specifications	<p>High-speed I/O block: Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p> <p>The diagram illustrates the timing sequence for JTAG operations. It shows four signals: TMS, TDI, TCK, and TDO. TMS and TDI are high-speed parallel data buses. TCK is a clock signal. TDO is the data output. Various timing parameters are defined between these signals, such as t<sub>JCP</sub>, t<sub>JCH</sub>, t<sub>JCL</sub>, t<sub>JPSU</sub>, t<sub>JPH</sub>, t<sub>JPZX</sub>, t<sub>JPCO</sub>, and t<sub>JPXZ</sub>.</p>
K, L, M, N, O, P	PLL Specifications	<p>PLL Specification parameters:</p> <p><b>Diagram of PLL Specifications (1)</b></p> <p>The diagram shows a detailed block diagram of a PLL. It includes a Core Clock input, a Synchronizer, a Phase Frequency Detector (PFD), a Charge Pump (CP), a Loop Filter (LF), a Voltage Controlled Oscillator (VCO), a VCO post-scale counter K (with a value of 2), a Counter CO.C9, and various output paths for CLKOUT pins, GCLK, and RCLK. A feedback path from the output is labeled "External Feedback". A key legend indicates that blue boxes represent "Reconfigurable in User Mode".</p> <p><b>Notes:</b></p> <ul style="list-style-type: none"> <li>(1) CoreClock can only be fed by dedicated clock input pins or PLL outputs.</li> <li>(2) This is the VCO post-scale counter K.</li> </ul>
Q, R	R <sub>L</sub>	Receiver differential input discrete resistor (external to the Arria II device).

**Table 1–68. Glossary (Part 4 of 4)**

<b>Letter</b>	<b>Subject</b>	<b>Definitions</b>
<b>U, V</b>	$V_{CM(DC)}$	DC common mode input voltage.
	$V_{ICM}$	Input common mode voltage: The common mode of the differential signal at the receiver.
	$V_{ID}$	Input differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.
	$V_{DIF(AC)}$	AC differential input voltage: Minimum AC input differential voltage required for switching.
	$V_{DIF(DC)}$	DC differential input voltage: Minimum DC input differential voltage required for switching.
	$V_{IH}$	Voltage input high: The minimum positive voltage applied to the input which is accepted by the device as a logic high.
	$V_{IH(AC)}$	High-level AC input voltage.
	$V_{IH(DC)}$	High-level DC input voltage.
	$V_{IL}$	Voltage input low: The maximum positive voltage applied to the input which is accepted by the device as a logic low.
	$V_{IL(AC)}$	Low-level AC input voltage.
	$V_{IL(DC)}$	Low-level DC input voltage.
	$V_{OCM}$	Output common mode voltage: The common mode of the differential signal at the transmitter.
	$V_{OD}$	Output differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter.
<b>W, X, Y, Z</b>	<b>W</b>	High-speed I/O block: The clock boost factor.

## Document Revision History

Table 1–69 lists the revision history for this chapter.

**Table 1–69. Document Revision History (Part 1 of 2)**

<b>Date</b>	<b>Version</b>	<b>Changes</b>
December 2013	4.4	Updated Table 1–34 and Table 1–35.
July 2012	4.3	<ul style="list-style-type: none"> <li>■ Updated the <math>V_{CCH\_GXBL/R}</math> operating conditions in Table 1–6.</li> <li>■ Finalized Arria II GZ information in Table 1–20.</li> <li>■ Added BLVDS specification in Table 1–32 and Table 1–33.</li> <li>■ Updated input and output waveforms in Table 1–68.</li> </ul>
December 2011	4.2	<ul style="list-style-type: none"> <li>■ Updated Table 1–32, Table 1–33, Table 1–34, Table 1–35, Table 1–40, Table 1–41, Table 1–54, and Table 1–67.</li> <li>■ Minor text edits.</li> </ul>
June 2011	4.1	<ul style="list-style-type: none"> <li>■ Added Table 1–60.</li> <li>■ Updated Table 1–32, Table 1–33, Table 1–38, Table 1–41, and Table 1–61.</li> <li>■ Updated the “Switching Characteristics” section introduction.</li> <li>■ Minor text edits.</li> </ul>